

March 2013

FPDB60PH60B PFC SPM[®] 3 Series for 2-Phase Bridgeless PFC

Features

- Low Thermal Resistance Thanks to AIN-DBC Substrate
- 600 V 60 A 2-Phase Bridgeless PFC Including A Drive IC for Gate Driving and Protection
- Built-In NTC Thermistor for Monitoring Over-Temperature
- · Built-In Shunt Resistor for Current Sensing
- · Typical Switching Frequency of 20 kHz
- Isolation Rating of 2500 Vrms/min.

Applications

• 2-Phase Bridgeless PFC Converter for Air Conditioner

General Description

FPDB60PH60B Is An Advanced PFC SPM 3 Series for 2-Phase Bridgeless PFC (Power Factor Correction) that Fairchild Has Newly Developed for Mid-Power Applications such as Air Conditioners. It Combines Optimized Circuit Protection and Drive IC Matched To High Frequency Switching IGBTs. The System Reliability Is Further Enhanced by The Integrated Under-Voltage Lock-Out and Over-Current Protection Function.

Related Source

• <u>AN-9041 - Bridgeless PFC SPM 3 Series Design</u> Guide

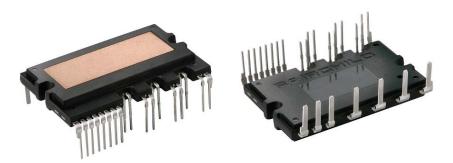


Fig. 1. Package Overview

Package Marking & Ordering Information

Device Marking	Device	Package	Packing Type	Reel Size	Tape Width	Quantity
FPDB60PH60B	FPDB60PH60B	SPMHC-027	RAIL	-	•	10

Integrated Power Functions

• PFC converter for single-phase AC/DC power conversion (Please refer to Fig. 3)

Integrated Drive, Protection and System Control Functions

- For IGBTs: Gate drive circuit, Over Current(OC) protection, Control supply circuit Under-Voltage(UV) protection
- Fault signal: Corresponding to OC and UV fault
- · Built-in thermistor: Over-temperature monitoring
- Input interface : Active-high interface, can work with 3.3 / 5 V Logic, Schmitt trigger input

Pin Configuration

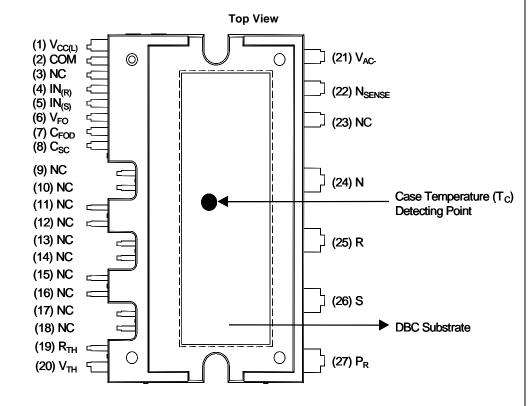
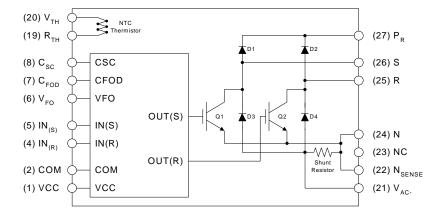


Fig. 2.

Pin Descriptions

Pin Number	Pin Name	Pin Description
1	V _{CC}	Common Bias Voltage for IC and IGBTs Driving
2	COM	Common Supply Ground
4	IN _(R)	Signal Input for Low-side R-phase IGBT
5	IN _(S)	Signal Input for Low-side S-phase IGBT
6	V _{FO}	Fault Output
7	C _{FOD}	Capacitor for Fault Output Duration Time Selection
8	C _{SC}	Capacitor (Low-pass Filter) for Over Current Detection
19	R _(TH)	NTC Thermistor terminal
20	V _(TH)	NTC Thermistor terminal
21	V _{AC-}	Current Sensing Terminal
22	N _{SENSE}	Current Sensing Reference Terminal
24	N	Negative Rail of DC–Link
25	R	Output for R Phase
26	S	Output for S Phase
27	P_{R}	Positive Rail of DC-Link
3, 9~18, 23	NC	No Connection

Internal Equivalent Circuit and Input/Output Pins



Note:
1) Converter is composed of two IGBTs including four diodes and one IC which has gate driving and protection functions.

Fig. 3.

Absolute Maximum Ratings (T_J = 25°C, Unless Otherwise Specified)

Converter Part

Item	Symbol	Condition	Rating	Unit
Supply Voltage	V _i	Applied between R-S	264	V_{RMS}
Supply Voltage (Surge)	V _{i(Surge)}	Applied between R-S	500	V
Output Voltage	V _{PN}	Applied between P- N	450	V
Output Voltage (Surge)	V _{PN(Surge)}	Applied between P- N	500	V
Collector-emitter Voltage	V _{CES}		600	V
Each IGBT collector current	±I _C	$T_C = 25^{\circ}C$	60	Α
Each IGBT collector current (Peak)	±I _{CP}	T _C = 25°C, Under 1 ms pulse width	90	Α
Collector Dissipation	P _C	T _C = 25°C per One IGBT	178	W
Repetitive Peak Reverse Voltage	V_{RRM}		600	V
Peak Forward Surge Current	I _{FSM}	Single half sine-wave	350	Α
Power Rating of Shunt Resistor	P _{RSH}	T _C < 125°C	2	W
Operating Junction Temperature	TJ	(Note 1)	-40 ~ 150	°C

Control Part

Item	Symbol	Condition	Rating	Unit
Control Supply Voltage	V _{CC}	Applied between V _{CC} - COM	20	V
Input Signal Voltage	V_{IN}	Applied between IN - COM	-0.3~17	V
Fault Output Supply Voltage	V_{FO}	Applied between V _{FO} - COM	-0.3~V _{CC} +0.3	V
Fault Output Current	I _{FO}	Sink Current at V _{FO} Pin	5	mΑ
Current Sensing Input Voltage	V _{SC}	Applied between C _{SC} - COM	-0.3~V _{CC} +0.3	V

Total System

Item	Symbol	Condition	Rating	Unit
Module Case Operation Temperature	T _C		-20 ~ 100	°C
Storage Temperature	T _{STG}		-40 ~ 150	°C
Isolation Voltage	V _{ISO}	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to DBC	2500	V _{rms}

Thermal Resistance

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Junction to Case Thermal	$R_{\theta(j-c)Q}$	IGBT	-	-	0.7	°C/W
Resistance	$R_{\theta(j-c)HD}$	High-side diode	-	-	1.5	°C/W
(Referenced to PKG center)	$R_{\theta(j-c)LD}$	Low-side diode	-	-	0.85	°C/W

Note : 1. The maximum junction temperature rating of the power chips integrated within the PFC SPM® product is 150° C(@T_C $\leq 100^{\circ}$ C).

Note : 2. For the measurement point of case temperature(T_C), please refer to Fig. 2.

$\textbf{Electrical Characteristics} \ \, (T_J = 25^{\circ}C, \, \text{Unless Otherwise Specified})$

Converter Part

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
IGBT saturation voltage	V _{CE(sat)}	$V_{CC} = 15 \text{ V}, V_{IN} = 5 \text{ V}; I_{C} = 50 \text{ A}$	-	2.0	2.5	V
High-side diode voltage	V _{FH}	I _F = 50 A	-	2.4	2.9	V
Low-side diode voltage	V_{FL}	I _F = 50 A	-	1.2	1.6	V
Switching Times	t _{ON}	$V_{PN} = 400 \text{ V}, V_{CC} = 15 \text{ V}, I_{C} = 60 \text{ A}$	-	560	-	ns
	t _{C(ON)}	V _{IN} = 0 V ↔ 5 V, Inductive Load (Note 3)	-	270	-	ns
	t _{OFF}		-	520	-	ns
	t _{C(OFF)}		-	110	-	ns
	t _{rr}		-	44	-	ns
	I _{rr}		-	6.5	-	Α
Current sensing resistor	R _{SENSE}		1.8	2.0	2.2	mΩ
Collector - emitter Leakage Current	I _{CES}	$V_{CE} = V_{CES}$	-	-	250	μА

Control Part

Item	Symbol	C	ondition	Min.	Тур.	Max.	Unit
Quiescent V _{CC} Supply Current	I _{QCCL}	V _{CC} = 15 V, IN = 0 V	V _{CC} - COM	-	-	26	mA
Fault Output Voltage	V_{FOH}	V _{SC} = 0 V, V _{FO} Circu	it: 4.7 kΩ to 5 V Pull-up	4.5	-	-	V
	V_{FOL}	V _{SC} = 1 V, V _{FO} Circu	it: 4.7 kΩ to 5 V Pull-up	-	-	0.8	V
Over Current Trip Level	V _{SC(ref)}	V _{CC} = 15 V		0.45	0.5	0.55	V
Supply Circuit Under-	UV _{CCD}	Detection Level		10.7	11.9	13.0	V
Voltage Protection	UV _{CCR}	Reset Level		11.2	12.4	13.2	V
Fault-out Pulse Width	t _{FOD}	C _{FOD} = 33 nF (Note	4)	1.4	1.8	2.0	ms
ON Threshold Voltage	V _{IN(ON)}	Applied between IN -	COM	3.0	-	-	V
OFF Threshold Voltage	V _{IN(OFF)}			-	-	0.8	V
Resistance of Thermistor	R _{TH}	@ T _C = 25°C (Note F	Fig. 9)	-	50	-	kΩ
		@ T _C = 80°C (Note F	Fig. 9)	-	5.76	-	kΩ

Recommended Operating conditions

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Input Supply Voltage	VI	Applied between R - S	180	-	264	V_{rms}
Output Voltage	V_{PN}	Applied between P - N	-	280	400	V
Control Supply Voltage	V _{CC}	Applied between V _{CC} - COM	13.5	15	16.5	V
Control Supply Variation	dV _{CC} /dt	Applied between IN - COM	-1	-	1	V/μs
PWM Input Signal	fpwM	$T_C \le 100$ °C, $T_A \le 125$ °C, Per IGBT	-	20	-	kHz

^{3. 1&}lt;sub>ON</sub> and t_{OFF} include the propagation delay time of the internal drive IC. t_{C(ON)} and t_{C(OFF)} are the switching time of IGBT itself under the given gate driving condition internally. For the detailed information, please see Fig. 4

Note
4. The fault-out pulse width t_{FOD} depends on the capacitance value of C_{FOD} according to the following approximate equation : $C_{FOD} = 18.3 \times 10^{-6} \times t_{FOD}[F]$

Electrical Characteristics

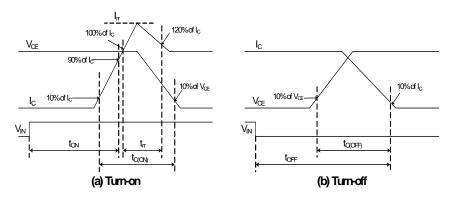


Fig. 4. Switching Time Definition

Mechanical Characteristics and Ratings

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Item		Min.	Тур.	Max.	Units	
Mounting Torque	Mounting Screw: M3	Recommended 0.62 N•m	0.51	0.62	0.72	N•m
Device Flatness	Note Fig. 5		0	-	+120	μm
Weight			-	15.00	-	g

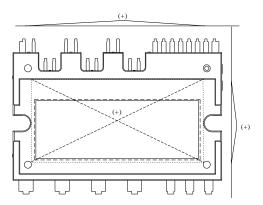
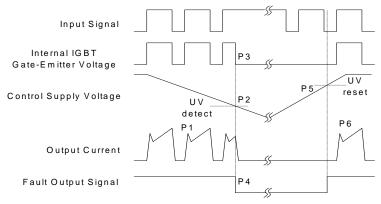


Fig. 5. Flatness Measurement Position

Time Charts of SPMs Protective Function

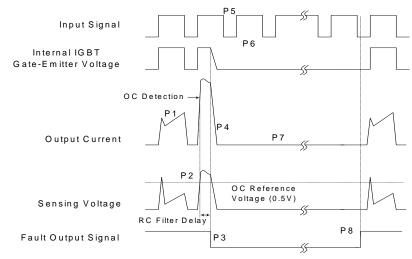


P1: Normal operation - IGBT ON and conducting current

P2 : Under voltage detection P3 : IGBT gate interrupt P4 : Fault signal generation P5 : Under voltage reset

P6: Normal operation - IGBT ON and conducting current

Fig. 6. Under-Voltage Protection



P1 : Normal operation - IGBT ON and conducting current

P2 : Over current detection

P3: IGBT gate interrupt / Fault signal generation

P4: IGBT is slowly turned off

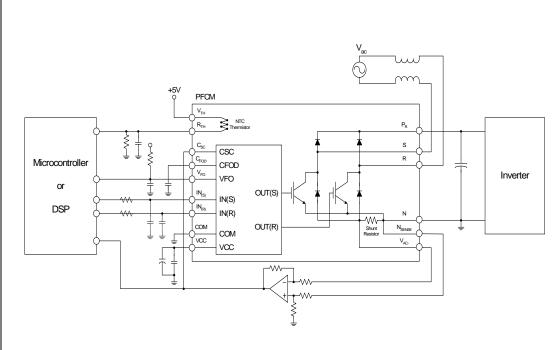
P5 : IGBT OFF signal

P6: IGBT ON signal - but IGBT cannot be turned on during the fault Output activation

P7: IGBT OFF state

P8: Fault Output reset and normal operation start

Fig. 7. Over Current Protection



Note:

1) For the over-current protection, please set the delay time in the range 3 ~ 4 $\mu s.$

Fig. 8. Application Example



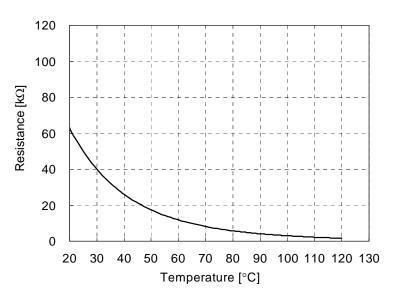
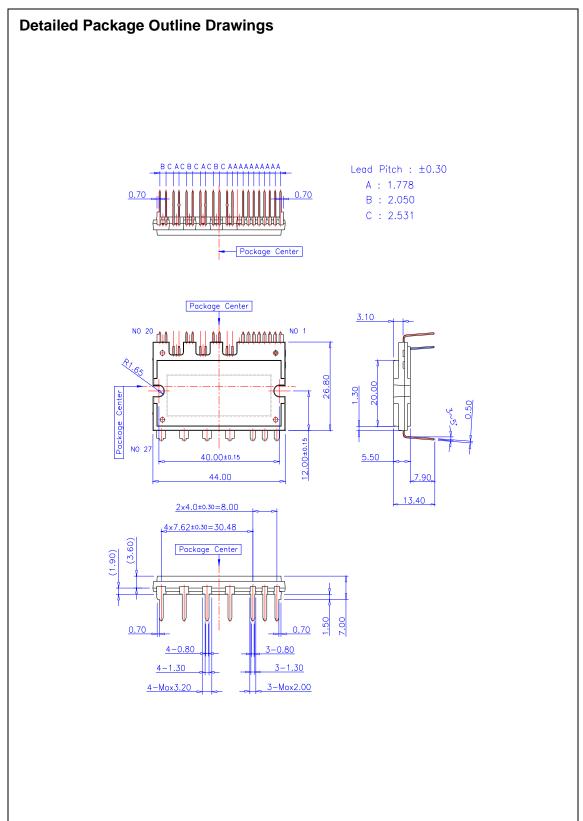
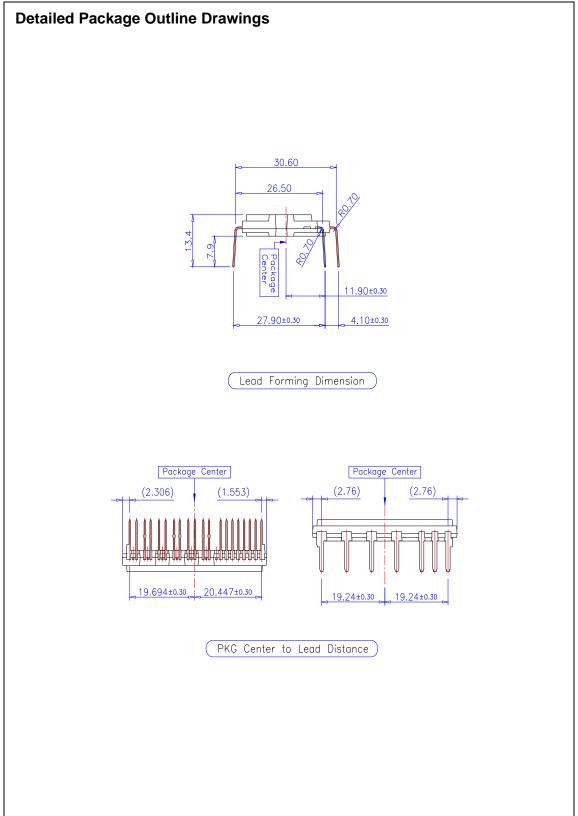
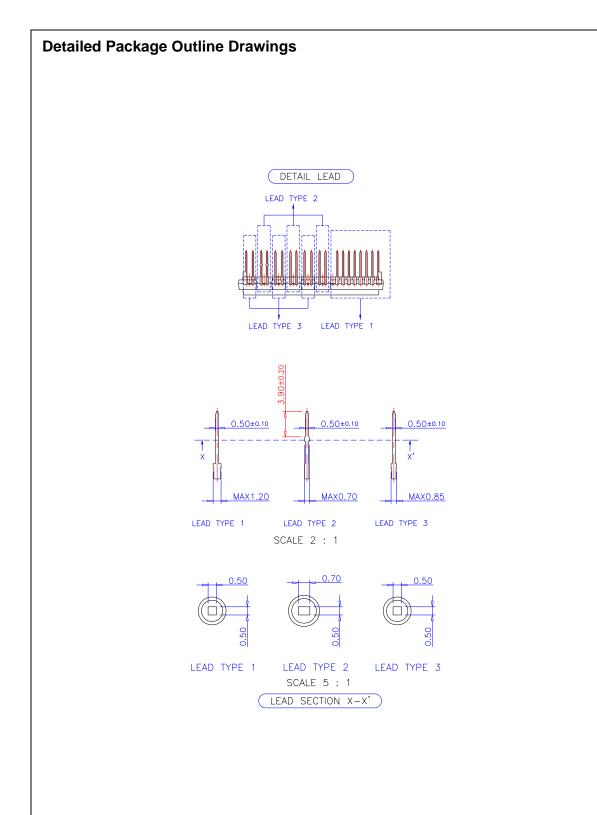


Fig. 9. R-T Curve of the Built-in Thermistor











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